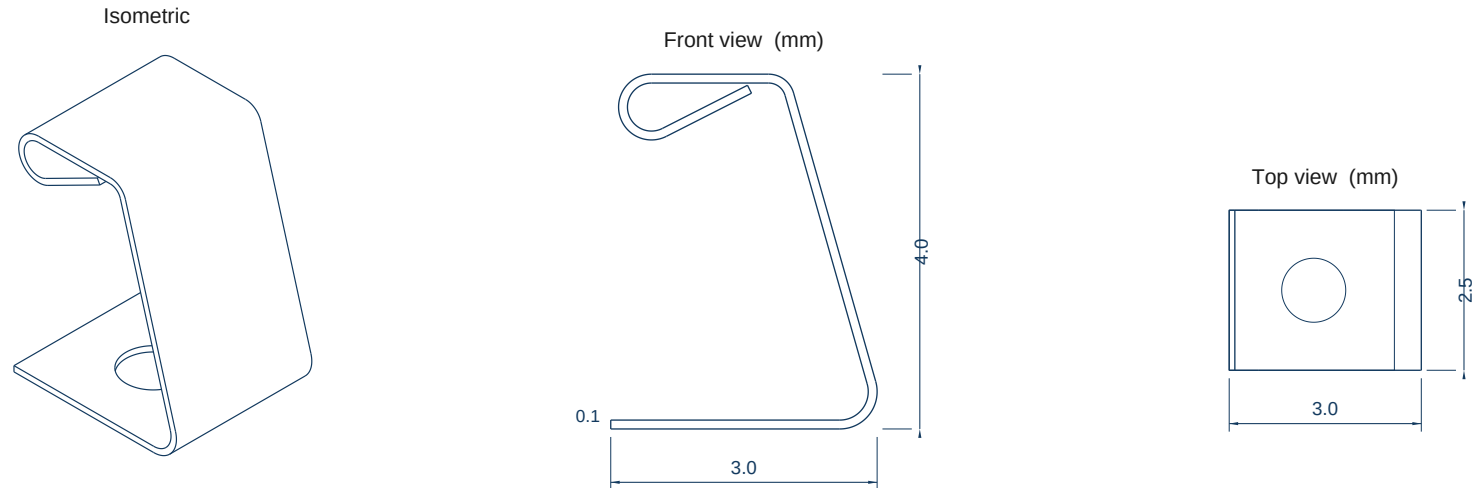




Type C-05 BC05-25030040

SMD EMI Spring Contact | Beryllium Copper | Units: mm



MECHANICAL

VALUE

Thickness	0.10 mm
Width	2.5 mm +/- 0.2
Length	3.0 mm +/- 0.2
Height	4.0 mm +/- 0.2
Form	base plate, back wall, top arm, folded hem tongue
Base bend	R0.370 CL, 106 deg
Top bend	R0.243 CL, 74 deg
Hem fold	R0.320 CL, 207 deg
Base hole	dia 1.00 mm at 1.32 from the wall end
Material / plating	BeCu, Gold-plated (G)
Volume / mass	2.548 mm ³ 21.3 mg (BeCu)
File format	STEP AP214

PRODUCT DATA

VALUE

Mfr P/N	BC05-25030040G-SY (Au)
Brand	Seyunda
Description	SMD EMI Contact 3.0x2.5x4.0mm Au
Packaging	Tape & Reel (TR)
Category	Connectors, Interconnects
Sub-category	Contacts, Spring Loaded (Pogo Pins), and Pressure
Lifecycle / origin	Active / Taiwan, Republic of China
RoHS / REACH	RoHS3 Compliant / REACH Unaffected
ECCN / ESD	EAR99 / Static sensitive: Yes
Datasheet	seyunda.com/datasheet/Seyunda-SMD-Spring-Contacts-Datasheet.pdf
Product page	seyunda.com/type-c-05.html (also listed on type-c-06.html)